



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

11/15/03  
5827

Applicant: George Arrigotti et al.

Inventor: Soldered Heat Sink Anchor and Method of Use

Docket No.: 884.997US1

Serial No.: 09/964812

Filed: September 28, 2001

Due Date: October 15, 2003

Examiner: Ishwar Patel

Group Art Unit: 2827

Customer No.: 21186

Confirmation No.: 2880

**MS Non-Fee Amendment**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Amendment and Response under 37 CFR 1.111 (14 Pages).
- ☒ Formal Drawings (8 pgs.).
- ☒ Revocation and Power of Attorney (2 pgs.)

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: Ann M. McCrackin  
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 15 day of October, 2003.

KACIA LEE  
Name

Kacia Lee  
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

(GENERAL)



**S/N 09/964812**

**PATENT**

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Applicant:	George Arrigotti et al.	Examiner:	Ishwar Patel
Serial No.:	09/964812	Group Art Unit:	2827
Filed:	September 28, 2001	Docket No.:	884.997US1
Title:	Soldered Heat Sink Anchor and Method of Use		
Assignee:	Intel Corporation	Customer No.:	21186

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**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on July 15, 2003. Please amend the above-identified patent application as follows.

**IN THE DRAWINGS**

Corrected drawings are supplied herewith.

Enclosed is a copy of Figures 2, 3, and 7 of the drawings showing the following proposed amendment to Figures 2, 3, and 7, in which cross-hatching has been executed for the solder 80 (FIG. 2), the solder, not labeled, (FIG. 3), and the solder 170 (FIG. 7).